



Per OSHPark specs,
min trace 5mil,
min space 5mil's,
min ringlet 4 mil's,
4 layer board stackup is as follows:
T-0 is top min 1 oz copper (1.4 mil)
min 6.7 mil prepreg FR4
T-1 is GND min 0.5 oz copper (0.7 mil)
min 47 mil core FR4
T-2 is PWR min 0.5 oz copper (0.7 mil)
min 6.7 mil prepreg FR4
T-3 is bottom min 1 oz copper (1.4 mil)

<http://rusefi.com/>

Sheet:

File: O2_input_CJ125.kicad_pcb

Title: CJ125 Wide O2

Size: A Date: 2019-01-08

KiCad E.D.A. kicad 4.0.7

Rev: R0.4.1

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